



## 30V P-Channel Trench Power MOSFET

### General Description

The SJP4953 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

### Features

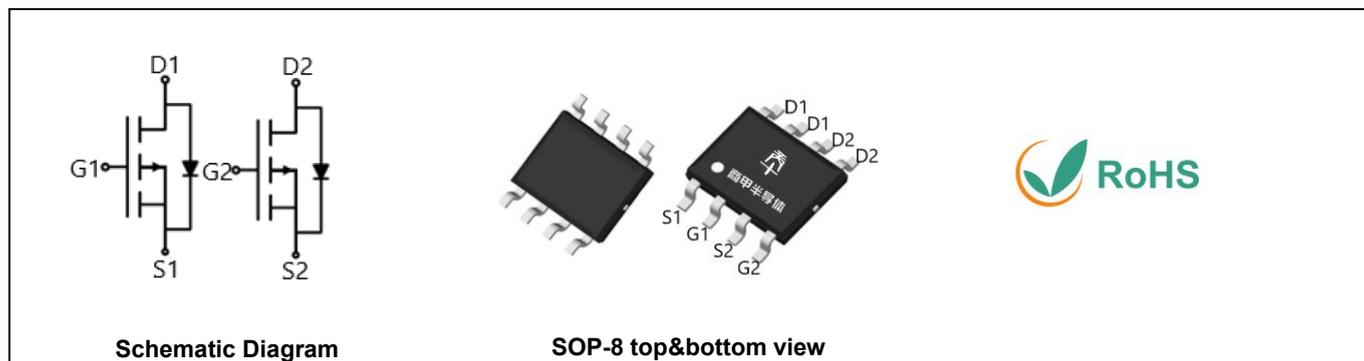
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

### Application

- PWM Applications
- Load Switch
- Power Management

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	-30	V
$R_{DS(ON\_TYP)}$	43.8	m $\Omega$
$I_D$	-4.4	A
$Q_G$	11	nC



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJP4953	SJP4953	SOP-8	Tape	\	\	4000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	-30	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ\text{C}$ )	-4.4	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	-2.8	A
$I_{DM}$ (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-17.6	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ\text{C}$ )	1.7	W
	Maximum Power Dissipation( $T_A=100^\circ\text{C}$ )	0.7	W
$E_{AS}$	Avalanche energy (Note 2)	20	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		73	$^\circ\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	-30			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-30V, V_{GS}=0V, T_J=25^\circ\text{C}$			1	$\mu A$
		$V_{DS}=-30V, V_{GS}=0V, T_J=125^\circ\text{C}$			100	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	$\mu A$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	-1		-2.5	V
$g_{FS}$	Forward Transconductance	$V_{DS}=-5V, I_D=-2A$		4		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-10V, I_D=-2A, T_J=25^\circ\text{C}$		43.8	54.8	m $\Omega$
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-4.5V, I_D=-1.5A, T_J=25^\circ\text{C}$		61	81.1	m $\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V, f=1.0\text{MHz}$		457		pF
$C_{oss}$	Output Capacitance			59		pF
$C_{rss}$	Reverse Transfer Capacitance			47		pF
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$		6.4		$\Omega$
<b>Switching Parameters</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=-10V, V_{DS}=-15V, R_L=7.5\Omega, R_{GEN}=3\Omega$		3		nS
$t_r$	Turn-on Rise Time			2		nS
$t_{d(off)}$	Turn-Off Delay Time			25		nS
$t_f$	Turn-Off Fall Time			15		nS
$Q_g$	Total Gate Charge	$V_{GS}=-10V, V_{DS}=-15V, I_D=-2A$		11		nC
$Q_{gs}$	Gate-Source Charge			2		nC
$Q_{gd}$	Gate-Drain Charge			2		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-Drain Current (Body Diode)				-4.4	A
$V_{SD}$	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=-2A$			1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F=-2A, dI/dt=100A/\mu s$		9		ns
$Q_{rr}$	Reverse Recovery Charge	$I_F=-2A, dI/dt=100A/\mu s$		3		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

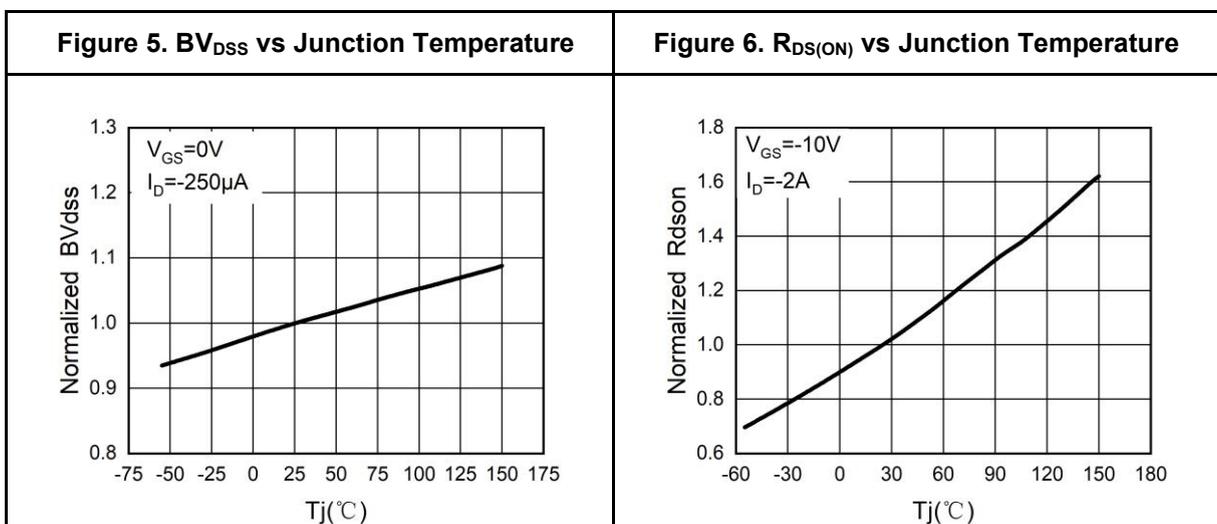
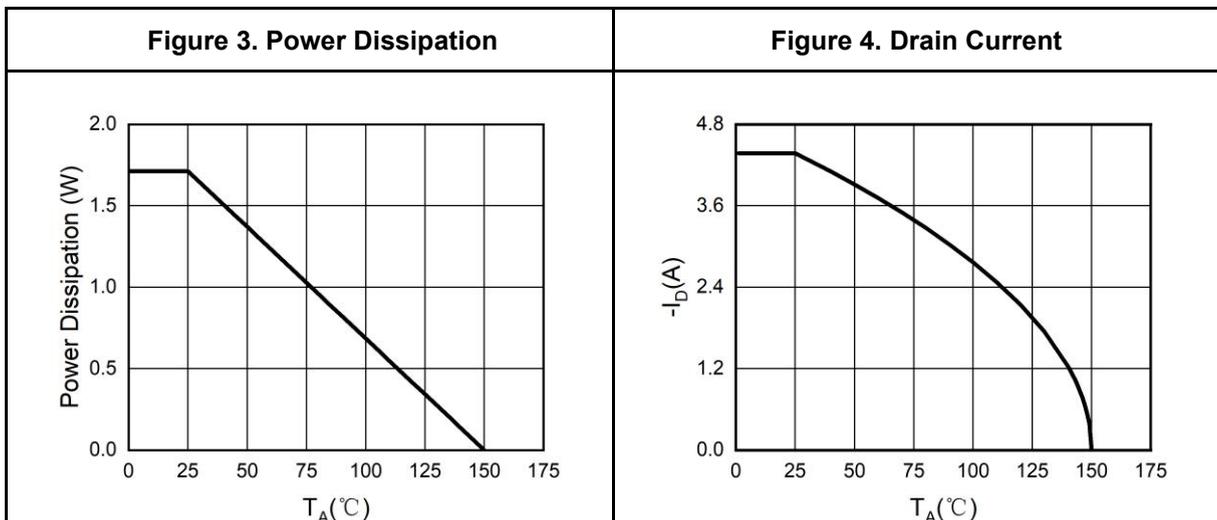
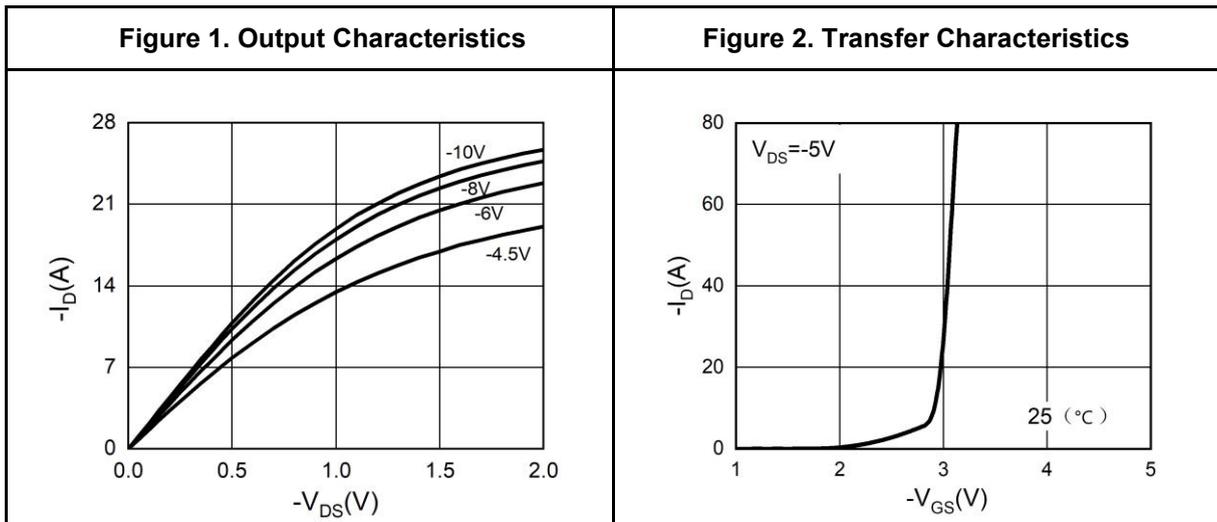
Notes 2.EAS condition:  $T_J=25^\circ\text{C}, V_{DD}=-30V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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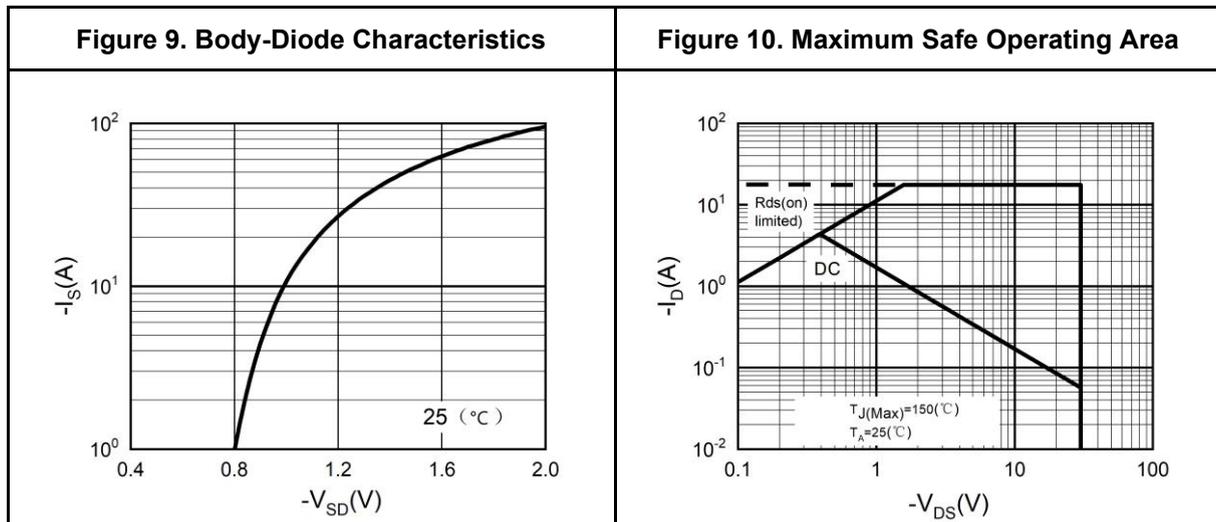
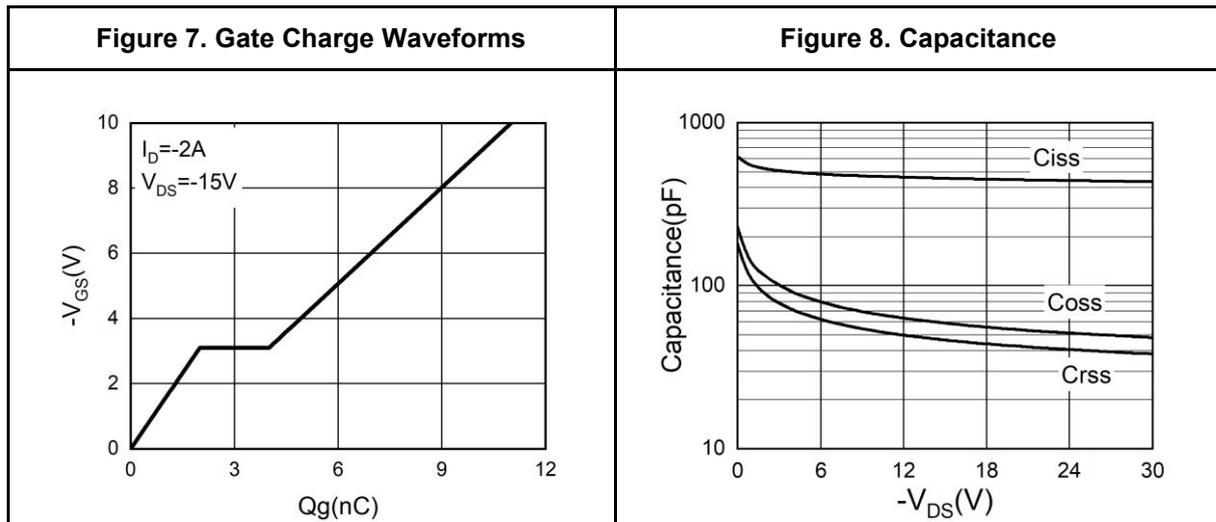
## Typical Electrical And Thermal Characteristics (Curves)





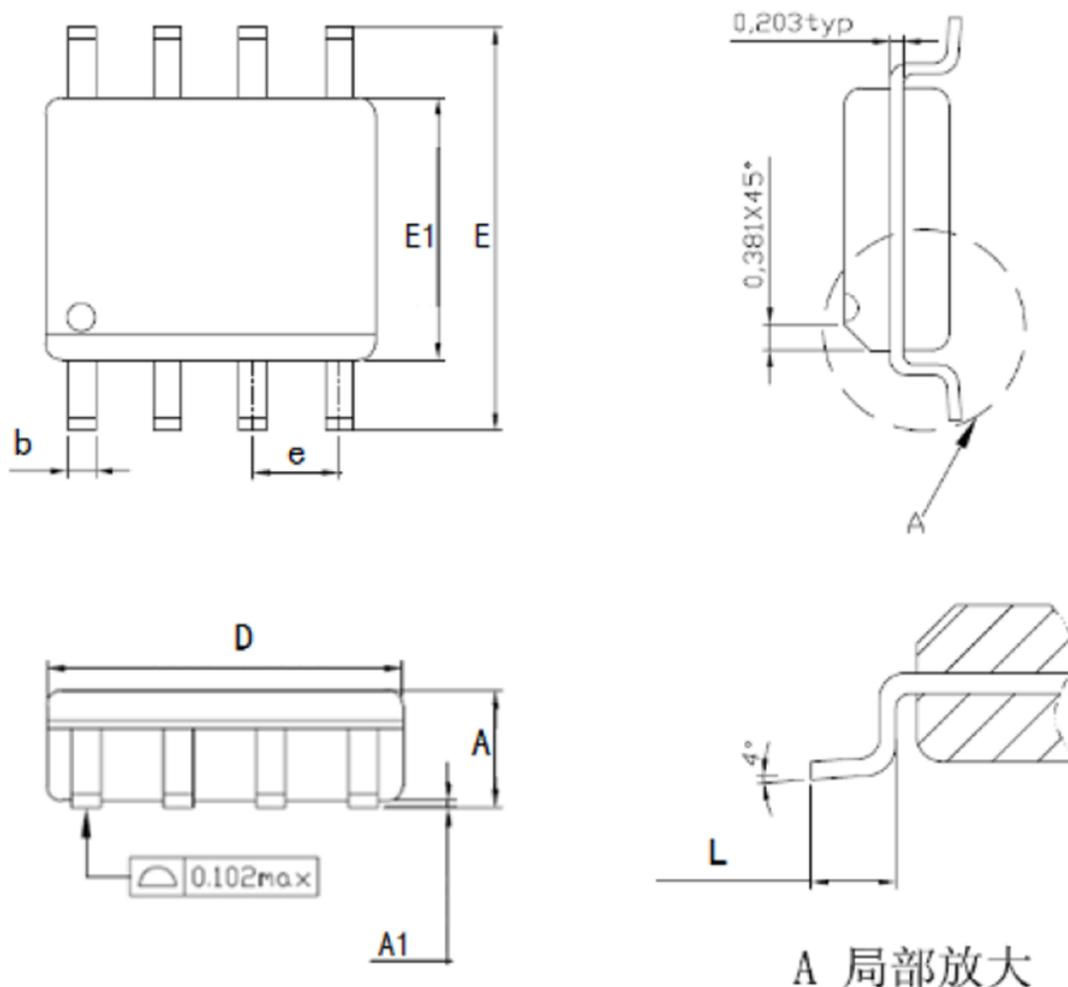
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## Typical Electrical And Thermal Characteristics (Curves)





SOP-8 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max
A	1.35	1.55	1.75
A1	0.1	0.15	0.2
b	0.346	0.406	0.466
D	4.8	4.89	4.98
E	5.75	6.00	6.25
E1	3.81	3.90	3.99
e	1.27TYP		
L	0.406	0.838	1.27



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